74LVC1G86

2-input EXCLUSIVE-OR gate Rev. 10 — 2 July 2012

Product data sheet

1. **General description**

The 74LVC1G86 provides the 2-input EXCLUSIVE-OR function.

Inputs can be driven from either 3.3 V or 5 V devices. These features allow the use of these devices in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial Power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Features and benefits 2.

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
 - ◆ JESD8-7 (1.65 V to 1.95 V)
 - ◆ JESD8-5 (2.3 V to 2.7 V)
 - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115-A exceeds 200 V
- \pm 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|-------------|-------------------|--------|--|----------|
| | Temperature range | Name | Description | Version |
| 74LVC1G86GW | –40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package; 5 leads; body width 1.25 mm | SOT353-1 |
| 74LVC1G86GV | –40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads | SOT753 |
| 74LVC1G86GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm | SOT886 |
| 74LVC1G86GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1 \times 0.5$ mm | SOT891 |
| 74LVC1G86GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm | SOT1115 |
| 74LVC1G86GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm | SOT1202 |
| 74LVC1G86GX | –40 °C to +125 °C | X2SON5 | X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body $0.8 \times 0.8 \times 0.35$ mm | SOT1226 |

4. Marking

Table 2. Marking codes

| Type number | Marking ^[1] |
|-------------|------------------------|
| 74LVC1G86GW | VH |
| 74LVC1G86GV | V86 |
| 74LVC1G86GM | VH |
| 74LVC1G86GF | VH |
| 74LVC1G86GN | VH |
| 74LVC1G86GS | VH |
| 74LVC1G86GX | VH |

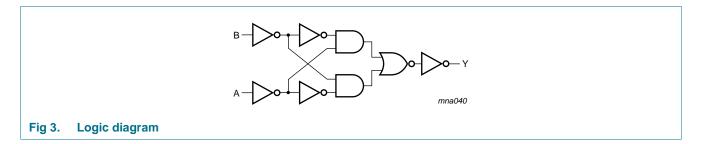
^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



NXP Semiconductors 74LVC1G86

2-input EXCLUSIVE-OR gate



6. Pinning information

6.1 Pinning



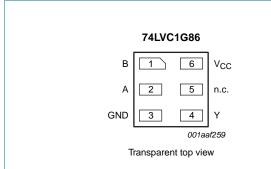


Fig 6. Pin configuration SOT891, SOT1115 and SOT1202

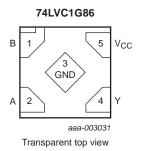


Fig 7. Pin configuration SOT1226 (X2SON5)

6.2 Pin description

Table 3. Pin description

| Symbol | Pin | | Description |
|----------|-------------------|-------|----------------|
| | TSSOP5 and X2SON5 | XSON6 | |
| В | 1 | 1 | data input |
| Α | 2 | 2 | data input |
| GND | 3 | 3 | ground (0 V) |
| Υ | 4 | 4 | data output |
| n.c. | - | 5 | not connected |
| V_{CC} | 5 | 6 | supply voltage |

7. Functional description

Table 4. Function table[1]

| Input | | Output |
|-------|---|--------|
| Α | В | Υ |
| L | L | L |
| L | Н | Н |
| Н | L | Н |
| Н | Н | L |

^[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|---------------------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| V_{I} | input voltage | | [<u>1]</u> -0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0 V$ | - | ±50 | mA |
| V _O | output voltage | Active mode | [<u>1][2]</u> –0.5 | $V_{CC} + 0.5$ | V |
| | | Power-down mode | [<u>1][2]</u> –0.5 | +6.5 | V |
| Io | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | ±50 | mA |
| I _{CC} | supply current | | - | +100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | [3] _ | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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^[2] When V_{CC} = 0 V (Power-down mode), the output voltage can be 5.5 V in normal operation.

^[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 and X2SON5 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|-------------------------------------|--|------|-----|----------|------|
| V_{CC} | supply voltage | | 1.65 | - | 5.5 | V |
| V _I | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | Active mode | 0 | - | V_{CC} | V |
| | | V _{CC} = 0 V; Power-down mode | 0 | - | 5.5 | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 1.65 V to 2.7 V | - | - | 20 | ns/V |
| | | V _{CC} = 2.7 V to 5.5 V | - | - | 10 | ns/V |

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 ' | -40 °C to +85 °C | | | -40 °C to +125 °C | |
|-----------------|--------------------------|--|-----------------------|------------------|---------------------|-----------------------|---------------------|----|
| | | | Min | Typ[1] | Max | Min | Max | |
| | HIGH-level | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 0.65V _{CC} | - | - | 0.65V _{CC} | - | V |
| | input voltage | V _{CC} = 2.3 V to 2.7 V | 1.7 | - | - | 1.7 | - | V |
| | | V _{CC} = 2.7 V to 3.6 V | 2.0 | - | - | 2.0 | - | V |
| | | V _{CC} = 4.5 V to 5.5 V | 0.7V _{CC} | - | - | 0.7V _{CC} | - | V |
| V _{IL} | LOW-level input | V _{CC} = 1.65 V to 1.95 V | - | - | 0.35V _{CC} | - | 0.35V _{CC} | V |
| | voltage | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | - | 0.7 | V |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | 0.8 | V |
| | | V _{CC} = 4.5 V to 5.5 V | - | - | $0.3V_{CC}$ | - | $0.3V_{CC}$ | V |
| V _{OH} | HIGH-level | $V_I = V_{IH}$ or V_{IL} | | | | | | |
| | output voltage | $I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | V _{CC} – 0.1 | - | - | V _{CC} – 0.1 | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | 0.95 | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | 1.7 | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | 1.9 | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.3 | - | - | 2.0 | - | V |
| | | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.8 | - | - | 3.4 | - | V |
| V _{OL} | LOW-level | $V_I = V_{IH}$ or V_{IL} | | | | | | |
| | output voltage | $I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | - | - | 0.10 | - | 0.10 | V |
| | | $I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.45 | - | 0.70 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.30 | - | 0.45 | V |
| | | $I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.40 | - | 0.60 | V |
| | | $I_O = 24 \text{ mA}$; $V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | - | 0.80 | V |
| | | $I_O = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | - | 0.55 | - | 0.80 | V |
| I _I | input leakage current | V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V | - | ±0.1 | ±5 | - | ±100 | μА |

Table 7. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 ° | °C to +85 | °C | -40 °C to | Unit | |
|------------------|------------------------------|---|-------|-----------|-----|-----------|------|----|
| | | | Min | Typ[1] | Max | Min | Max | |
| I _{OFF} | power-off leakage current | $V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$ | - | ±0.1 | ±10 | - | ±200 | μΑ |
| I _{CC} | supply current | $V_I = 5.5 \text{ V or GND}; I_O = 0 \text{ A};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | - | 0.1 | 10 | - | 200 | μΑ |
| ΔI_{CC} | additional supply current | per pin; V_{CC} = 2.3 V to 5.5 V; $V_I = V_{CC} - 0.6$ V; I_O = 0 A | - | 5 | 500 | - | 5000 | μΑ |
| C _I | input capacitance | $V_{CC} = 3.3 \text{ V}; V_I = \text{GND to } V_{CC}$ | - | 5 | - | - | - | pF |

^[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for load circuit see Figure 9.

| Symbol | Parameter | Conditions | | -40 | -40 °C to +85 °C | | -40 °C t | o +125 °C | Unit |
|-----------------|-------------------|--|-----|-----|------------------|-----|----------|-----------|------|
| | | | | Min | Typ[1] | Max | Min | Max | |
| t _{pd} | propagation delay | A, B to Y; see Figure 8 | [2] | | 1 | 1 | ' | 1 | ' |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.0 | 3.7 | 9.9 | 1.0 | 13.0 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 0.5 | 2.5 | 5.5 | 0.5 | 7.0 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | | 0.5 | 2.8 | 5.8 | 0.5 | 7.5 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 0.5 | 2.3 | 5.0 | 0.5 | 6.5 | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 0.5 | 1.9 | 4.0 | 0.5 | 5.5 | ns |
| C_{PD} | power dissipation | $V_I = GND$ to V_{CC} | [3] | | | | | | |
| | capacitance | $V_{CC} = 3.3 \text{ V}$ | | - | 25 | - | - | - | рF |

^[1] All typical values are measured at nominal V_{CC} .

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

^[2] t_{pd} is the same as t_{PLH} and t_{PHL}

^[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

2-input EXCLUSIVE-OR gate

12. Waveforms

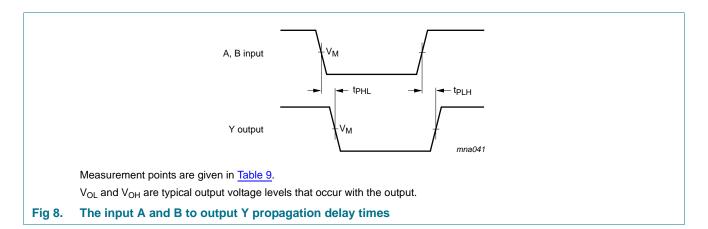
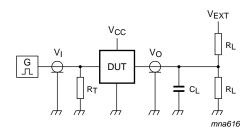


Table 9. Measurement points

| Supply voltage | Input | Output | |
|------------------|--------------------|--------------------|--|
| V _{CC} | V _M | V _M | |
| 1.65 V to 1.95 V | 0.5V _{CC} | 0.5V _{CC} | |
| 2.3 V to 2.7 V | 0.5V _{CC} | 0.5V _{CC} | |
| 2.7 V | 1.5 V | 1.5 V | |
| 3.0 V to 3.6 V | 1.5 V | 1.5 V | |
| 4.5 V to 5.5 V | 0.5V _{CC} | 0.5V _{CC} | |

2-input EXCLUSIVE-OR gate



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

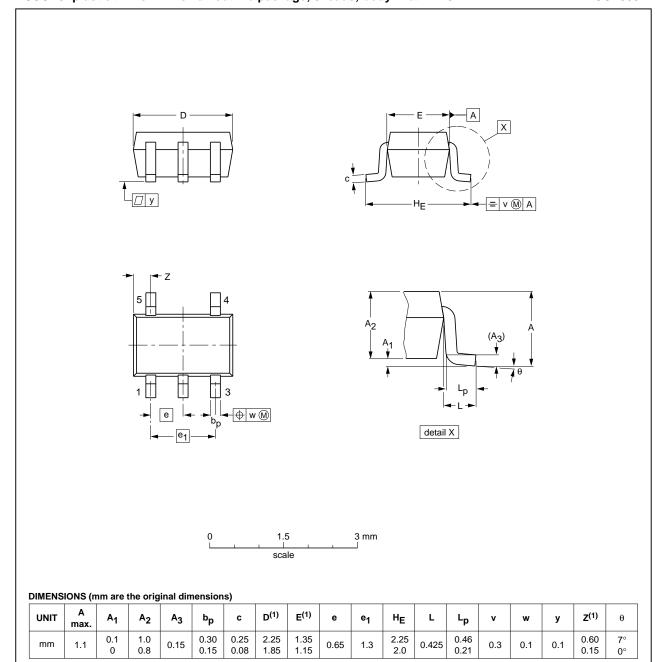
Table 10. Test data

| Supply voltage | Input | iput | | Load | | |
|------------------|-----------------|-------------|-------|----------------|-------------------------------------|--|
| V _{CC} | V _I | $t_r = t_f$ | CL | R _L | t _{PLH} , t _{PHL} | |
| 1.65 V to 1.95 V | V_{CC} | ≤ 2.0 ns | 30 pF | 1 kΩ | open | |
| 2.3 V to 2.7 V | V_{CC} | ≤ 2.0 ns | 30 pF | 500 Ω | open | |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open | |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open | |
| 4.5 V to 5.5 V | V _{CC} | ≤ 2.5 ns | 50 pF | 500 Ω | open | |

13. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE | REFER | | REFERENCES | | EUROPEAN | ISSUE DATE |
|----------|-------|--------|------------|--|------------|----------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT353-1 | | MO-203 | SC-88A | | | -00-09-01 03-02-19 |

Fig 10. Package outline SOT353-1 (TSSOP5)

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Plastic surface-mounted package; 5 leads

SOT753

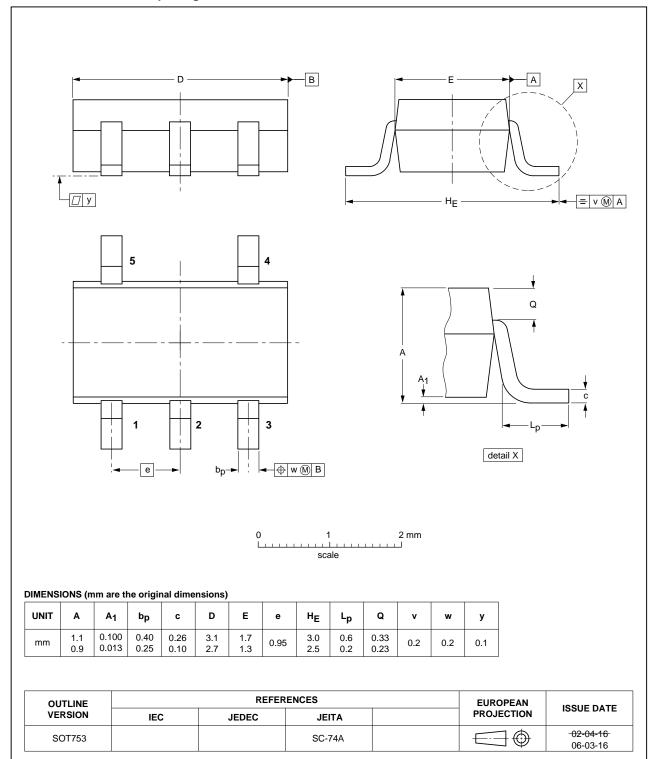


Fig 11. Package outline SOT753 (SC-74A)

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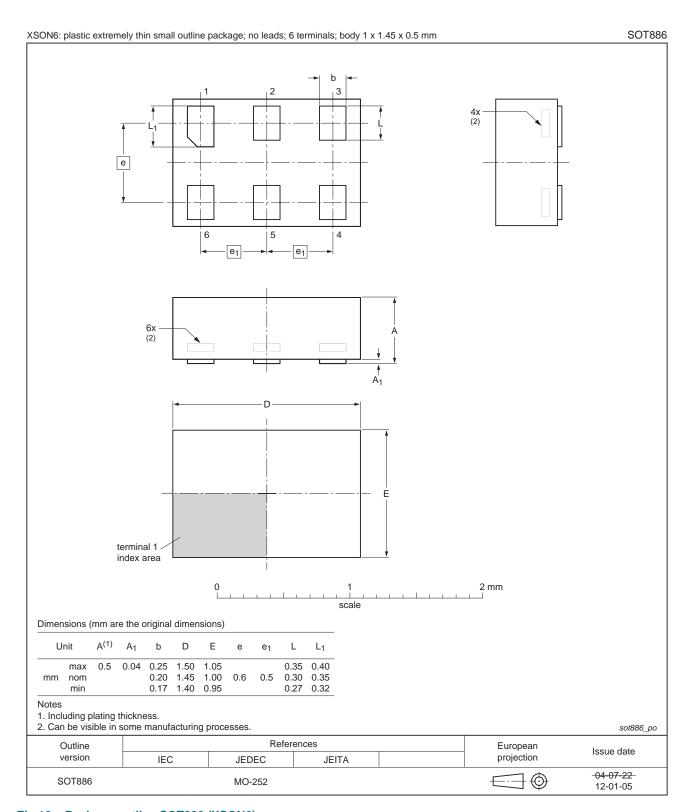


Fig 12. Package outline SOT886 (XSON6)

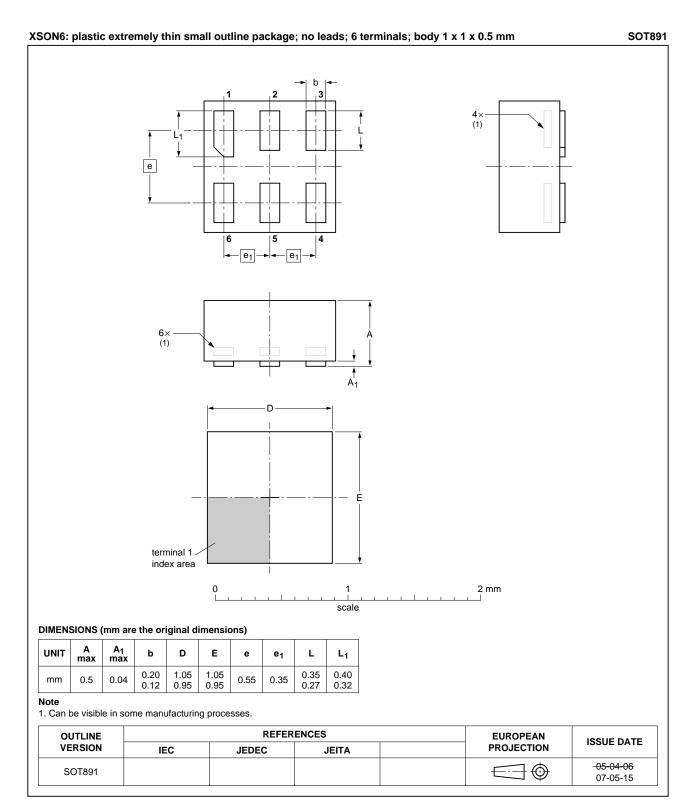


Fig 13. Package outline SOT891 (XSON6)

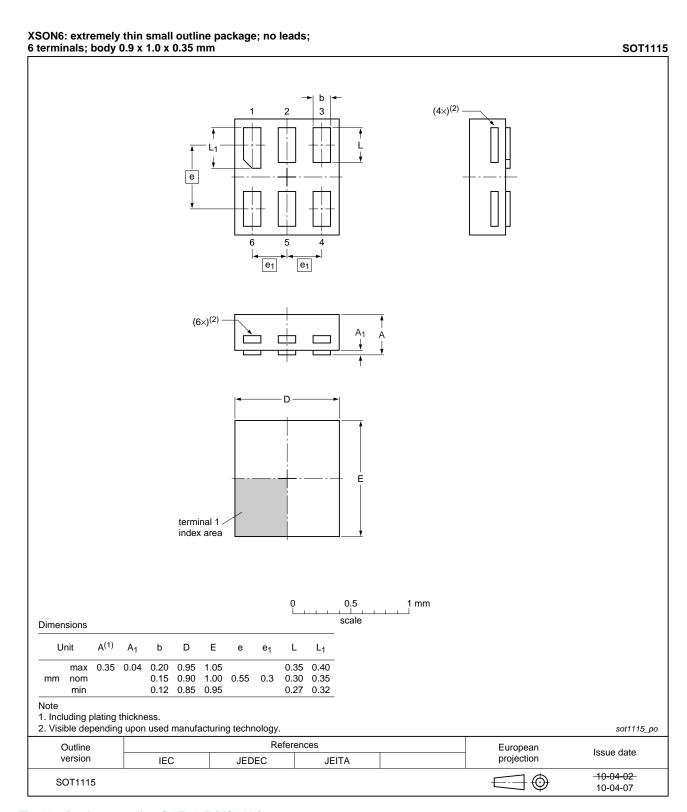


Fig 14. Package outline SOT1115 (XSON6)

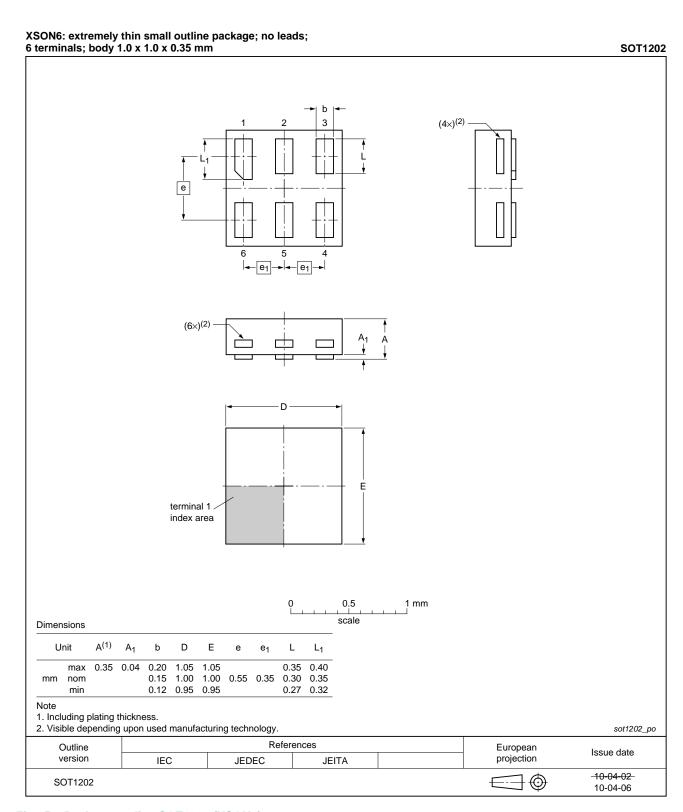


Fig 15. Package outline SOT1202 (XSON6)

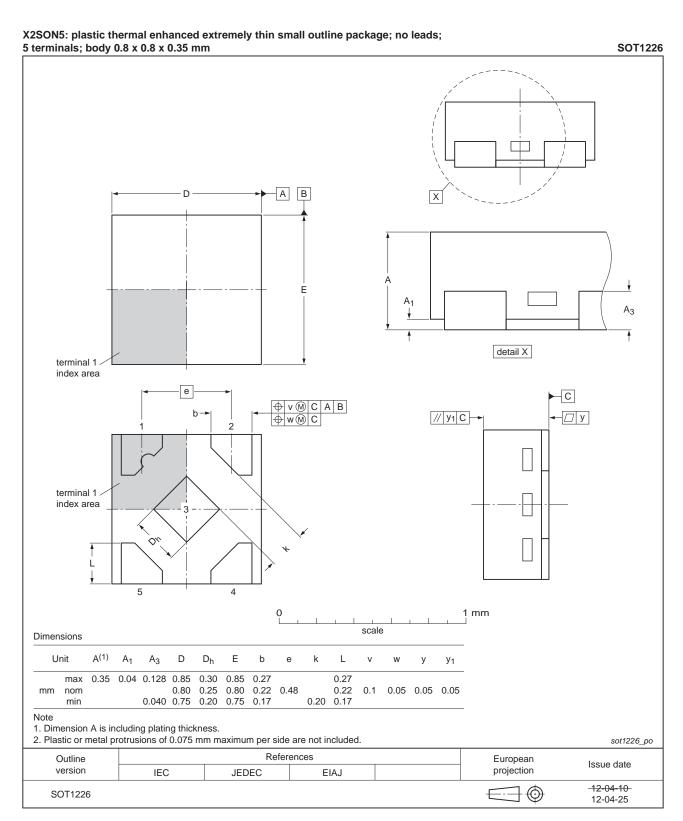


Fig 16. Package outline SOT1226 (X2SON5)

14. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

15. Revision history

Table 12. Revision history

| Document ID Release date Data sheet status Change notice Supersedes 74LVC1G86 v.10 20120702 Product data sheet - 74LVC1G86 v.9 Modifications: • Added type number 74LVC1G86GX (SOT1226) 74LVC1G86 v.9 20120305 Product data sheet - 74LVC1G86 v.8 Modifications: • Package outline drawing of SOT886 (Figure 12) modified. 74LVC1G86 v.8 20111201 Product data sheet - 74LVC1G86 v.7 Modifications: • Legal pages updated. 74LVC1G86 v.7 20100914 Product data sheet - 74LVC1G86 v.6 74LVC1G86 v.6 20070718 Product data sheet - 74LVC1G86 v.5 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 74LVC1G86 v.1 20001323 Preliminary specification - 74LVC1G86 v.1 | | | | | | |
|---|----------------|---|---------------------------|---------------|---------------|--|
| Modifications: ● Added type number 74LVC1G86GX (SOT1226) 74LVC1G86 v.9 20120305 Product data sheet - 74LVC1G86 v.8 Modifications: ● Package outline drawing of SOT886 (Figure 12) modified. 74LVC1G86 v.8 20111201 Product data sheet - 74LVC1G86 v.7 Modifications: ● Legal pages updated. 74LVC1G86 v.7 20100914 Product data sheet - 74LVC1G86 v.6 74LVC1G86 v.6 20070718 Product data sheet - 74LVC1G86 v.5 74LVC1G86 v.5 20060913 Product data sheet - 74LVC1G86 v.4 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 | Document ID | Release date | Data sheet status | Change notice | Supersedes | |
| 74LVC1G86 v.9 20120305 Product data sheet - 74LVC1G86 v.8 Modifications: ● Package outline drawing of SOT886 (Figure 12) modified. 74LVC1G86 v.8 20111201 Product data sheet - 74LVC1G86 v.7 Modifications: ● Legal pages updated. 74LVC1G86 v.7 20100914 Product data sheet - 74LVC1G86 v.6 74LVC1G86 v.6 20070718 Product data sheet - 74LVC1G86 v.5 74LVC1G86 v.5 20060913 Product data sheet - 74LVC1G86 v.4 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.3 20021115 Product specification - 74LVC1G86 v.2 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 | 74LVC1G86 v.10 | 20120702 | Product data sheet | - | 74LVC1G86 v.9 | |
| Modifications: ● Package outline drawing of SOT886 (Figure 12) modified. 74LVC1G86 v.8 20111201 Product data sheet - 74LVC1G86 v.7 Modifications: ● Legal pages updated. 74LVC1G86 v.7 20100914 Product data sheet - 74LVC1G86 v.6 74LVC1G86 v.6 20070718 Product data sheet - 74LVC1G86 v.5 74LVC1G86 v.5 20060913 Product data sheet - 74LVC1G86 v.4 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.3 20021115 Product specification - 74LVC1G86 v.2 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 | Modifications: | Added type | number 74LVC1G86GX (SOT | 1226) | | |
| 74LVC1G86 v.8 20111201 Product data sheet - 74LVC1G86 v.7 Modifications: ● Legal pages updated. 74LVC1G86 v.7 20100914 Product data sheet - 74LVC1G86 v.6 74LVC1G86 v.6 20070718 Product data sheet - 74LVC1G86 v.5 74LVC1G86 v.5 20060913 Product data sheet - 74LVC1G86 v.4 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.3 20021115 Product specification - 74LVC1G86 v.2 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 | 74LVC1G86 v.9 | 20120305 | Product data sheet | - | 74LVC1G86 v.8 | |
| Modifications: ● Legal pages updated. 74LVC1G86 v.7 20100914 Product data sheet - 74LVC1G86 v.6 74LVC1G86 v.6 20070718 Product data sheet - 74LVC1G86 v.5 74LVC1G86 v.5 20060913 Product data sheet - 74LVC1G86 v.4 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.3 20021115 Product specification - 74LVC1G86 v.2 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 | Modifications: | ons: • Package outline drawing of SOT886 (Figure 12) modified. | | | | |
| 74LVC1G86 v.7 20100914 Product data sheet - 74LVC1G86 v.6 74LVC1G86 v.6 20070718 Product data sheet - 74LVC1G86 v.5 74LVC1G86 v.5 20060913 Product data sheet - 74LVC1G86 v.4 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.3 20021115 Product specification - 74LVC1G86 v.2 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 | 74LVC1G86 v.8 | 20111201 | Product data sheet | - | 74LVC1G86 v.7 | |
| 74LVC1G86 v.6 20070718 Product data sheet - 74LVC1G86 v.5 74LVC1G86 v.5 20060913 Product data sheet - 74LVC1G86 v.4 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.3 20021115 Product specification - 74LVC1G86 v.2 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 | Modifications: | Legal pages | updated. | | | |
| 74LVC1G86 v.5 20060913 Product data sheet - 74LVC1G86 v.4 74LVC1G86 v.4 20040908 Product specification - 74LVC1G86 v.3 74LVC1G86 v.3 20021115 Product specification - 74LVC1G86 v.2 74LVC1G86 v.2 20010406 Preliminary specification - 74LVC1G86 v.1 | 74LVC1G86 v.7 | 20100914 | Product data sheet | - | 74LVC1G86 v.6 | |
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|--------------------------------|-------------------|---|
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